

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT4824180

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	COVIDIEN ENGINEERING SERVICES PRIVATE LIMITED	11/21/2017
RECEIVING PARTY DATA		
Name:	COVIDIEN PRIVATE LIMITED	
Street Address:	50 PASIR PANJANG ROAD #04-51 MAPLETREE BUSINESS CITY	
City:	SINGAPORE	
State/Country:	SINGAPORE	
Postal Code:	117384	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	14933166
CORRESPONDENCE DATA		
Fax Number:	(303)581-6632	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	303-530-2300	
Email:	SurgicalUS@covidien.com, medtronic_mitg-si_docketing@cardinal-ip.com	
Correspondent Name:	COVIDIEN LP	
Address Line 1:	5920 LONGBOW DRIVE	
Address Line 2:	ATTN: IP LEGAL	
Address Line 4:	BOULDER, COLORADO 80301	
ATTORNEY DOCKET NUMBER:	356278 (203-10896)	
NAME OF SUBMITTER:	THOMAS A. BEATON	
SIGNATURE:	/Thomas A. BEATON/	
DATE SIGNED:	02/14/2018	
Total Attachments: 3		
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DEED OF ASSIGNMENT

THIS DEED OF ASSIGNMENT IS EXECUTED BY

Covidien Engineering Services Private Limited, having registered address at DLF Cyber City, Block No.3, Ground Floor, Plot No.129 to 132, APHB Colony, Gachibowli, Hyderabad, 500019 India (hereinafter 'Assignor') (which expression unless repugnant to the meaning or context thereof shall mean and include its successors and Assigns) and represented by its authorized signatory Mr/ Ms. Divya Prakash Joshi of the **ONE PART;**

IN FAVOUR OF

Covidien Private Limited, having main address at 50 Pasir Panjang Road, #04-51 Mapletree Business City, Singapore, 117384 (hereinafter 'Assignee') (which expression unless repugnant to the meaning or context thereof shall mean and include its successors and Assigns) and represented by its authorized signatory Mr./Ms. Ryo Noda of the **OTHER PART;**

WHEREAS the Assignor is the sole owner of invention(s) and patent application(s) :

See Attached Schedule A

hereinafter referred to as the "Inventions"

NOW THEREFORE, with reference to the Research and Development Services Agreement between the Assignor and the Assignee effective as of April 6, 2011, it is agreed that for the consideration of US Dollars Ten Only (US\$10.00), the Assignor does hereby assign and transfer to Assignee the full interest of Assignor's right and title in the Inventions above and in the patent application with the filing number listed above as well as in all other applications, utility model applications, design applications filed in any country and other intellectual property rights basing priority on the patent application above including the right to claim priority under the Paris Convention for the Protection of Industrial Property, all re-examination applications, all re-issue applications, and any patents, utility models, designs or other intellectual property rights which may issue for the Inventions above. All interests in property in the Inventions and application(s) above are herewith transferred to the Assignee.

Assignor further agrees and warrants to execute all such further papers and perform such other acts as Assignee may reasonably request to obtain or maintain such patents, utility models, designs or other intellectual property rights in any country.

Authorized signatory of Assignor

Signature

Name: DIVYAPRAKASH JOSHI [SITE DIRECTOR, MEIC]

Place, Date: Hyderabad, 21 NOV 2017

[Company Seal/Stamp]

Witness of Assignor:

Signature

Name: AMAR SINGH JADHAV

Place, Date: HYDERABAD (21 NOV 2017)

Assignee hereby acknowledges and agrees to such assignment and transfer

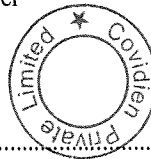
Authorised signatory of Assignee

Signature

Name Ryo Noda

Place, Date Singapore, 18 JAN 2018

[Company Seal/Stamp]



Witness of Assignee:

Signature

Name: Choong Hwei Fong

Place, Date: Singapore, 18 JAN 2018

Patents and Patent Applications

PATENT